



PATENT

In re application of:

MUNEKATA ET AL

Serial No.: 10/666,129 Art Unit: 1742

Filed: September 22, 2003 Examiner: Sikyin Ip

For: LEAD-FREE SOLDER ALLOY

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

A preliminary amendment in the above-identified patent application is attached.

No additional claim fee is required.

The claim fee has been calculated as shown below:

(Col. 1)	(Col. 2)	(Col. 3)	SMALL ENTITY	OTHER THAN A SMALL ENTITY
//////	CLAIMS	/////	HIGHEST NO.	
//////	REMAINING	/////	PREVIOUSLY PAID FOR	PRESENT EXTRA
//////	AFTER	/////		
//////	AMENDMENT	/////		
TOTAL	* 20	MINUS ** 20	= 0	
INDEP	* 1	MINUS *** 3	= 0	
FIRST PRESENTATION OF MULT. DEP. CLAIM			RATE	ADDIT. FEE
			x 9= \$	RATE ADDIT. FEE
			x 43= \$	x 18= \$ 0
			+145 \$	x 86= \$ 0
			TOTAL \$	+290= \$
				TOTAL \$ 0

\* If entry in Col. 1 is less than that in Col. 2, write "0" in Col. 3.

\*\* If the highest no. previously paid for IN THIS SPACE is less than 20, write "20" in this space.

\*\*\* If the highest no. previously paid for IN THIS SPACE is less than 3, write "3" in this space.

- Please charge Deposit Account No. 50-1079 in the amount of \$.
- A check in the amount of \$ is attached.
- The Commissioner is authorized to charge any deficiency in the following fees associated with this communication and to credit any excess payment to Deposit Account No. 50-1079. A duplicate copy of this letter is attached.
- Any filing fees pursuant to 37 CFR §1.16 for the presentation of extra claims.
- Any patent application processing fees pursuant to 37 CFR §1.17, including extension of time fees pursuant to 37 CFR §1.17(a)-(d).

Respectfully submitted,



Michael Tobias  
Registration Number 32,948

#40  
1717 K Street, N.W., Suite 613  
Washington, D.C. 20036  
Telephone: (301) 587-6541  
Facsimile: (301) 587-6623  
Date: Jan 27, 2004



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

MUNEKATA ET AL

Application No.: 10/666,129

Art Unit: 1742

Filed: September 22, 2003

Examiner: Sikyin Ip

For: LEAD-FREE SOLDER ALLOY

PRELIMINARY AMENDMENT

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Prior to examination, please amend the present application  
as shown below.

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